



81CXX/81NXX

CMOS IC

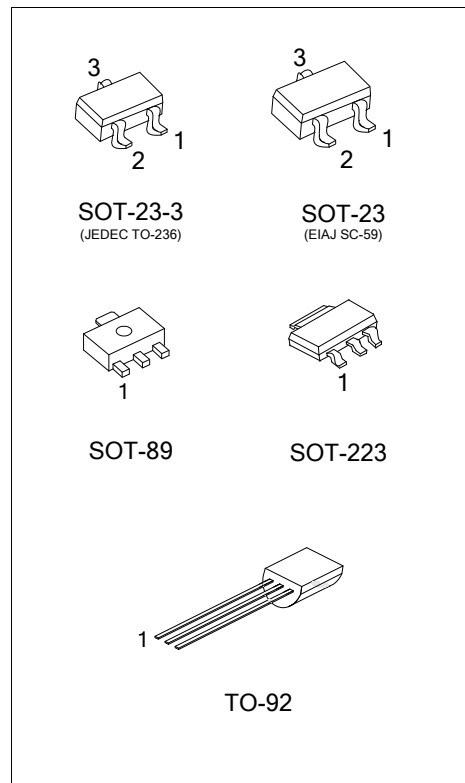
VOLTAGE DETECTORS WITH BUILT-IN DELAY TIME

DESCRIPTION

The UTC **81CXX** and **81NXX** series are good performance voltage detector and manufactured by CMOS technologies with highly accurate, low power consumption. A delay circuit is built-in to each detector, therefore, peripherals are unnecessary and high density mounting is possible. Detect voltage is extremely accurate with minimal temperature drift. Both CMOS and N-channel open drain output configurations are available.

FEATURES

- * Highly Accurate: Detect voltage $\pm 2\%$
- * Built-In Delay time : 1ms ~ 50ms
50ms ~ 200ms
200ms ~ 400ms
- * Detect Voltage Temperature Characteristics: TYP $\pm 100\text{ppm}/^\circ\text{C}$
- * Wide Operating Voltage Range : 0.7V ~ 10.0V
- * Low Current Consumption : TYP 1.0 μA ($V_{\text{IN}}=2.0\text{V}$)



ORDERING INFORMATION

CMOS:

Ordering Number		①:Delay Time		Package	Pin Assignment			Packing
Lead Free	Halogen Free	Duration	Code		1	2	3	
81CXXL-①-AA3-B-R	81CXXG-①-AA3-B-R	1~50 50~200 200~400	ms ms ms	SOT-223	O	G	I	Tape Reel
81CXXL-①-AB3-E-R	81CXXG-①-AB3-E-R			SOT-89	O	I	G	Tape Reel
81CXXL-①-AE3-3-R	81CXXG-①-AE3-3-R			SOT-23	O	G	I	Tape Reel
81CXXL-①-AE3-5-R	81CXXG-①-AE3-5-R			SOT-23	G	O	I	Tape Reel
81CXXL-①-AE3-2-R	81CXXG-①-AE3-2-R			SOT-23	I	O	G	Tape Reel
81CXXL-①-AE2-3-R	81CXXG-①-AE2-3-R			SOT-23-3	O	G	I	Tape Reel
81CXXL-①-AE2-5-R	81CXXG-①-AE2-5-R			SOT-23-3	G	O	I	Tape Reel
81CXXL-①-AE2-2-R	81CXXG-①-AE2-2-R			SOT-23-3	I	O	G	Tape Reel
81CXXL-①-T92-D-B	81CXXG-①-T92-D-B			TO-92	I	G	O	Tape Box
81CXXL-①-T92-E-B	81CXXG-①-T92-E-B			TO-92	O	I	G	Tape Box
81CXXL-①-T92-D-K	81CXXG-①-T92-D-K			TO-92	I	G	O	Bulk
81CXXL-①-T92-E-K	81CXXG-①-T92-E-K			TO-92	O	I	G	Bulk
81CXXL-①-T92-D-R	81CXXG-①-T92-D-R			TO-92	I	G	O	Tape Reel
81CXXL-①-T92-E-R	81CXXG-①-T92-E-R			TO-92	O	I	G	Tape Reel

■ ORDERING INFORMATION(Cont.)

N-Channel:

Ordering Number		①:Delay Time		Package	Pin Assignment			Packing	
Lead Free	Halogen Free	Duration	Code		1	2	3		
81NXXL-①-AA3-B-R	81NXXG-①-AA3-B-R	1~50 50~200 200~400	ms ms ms	H J K	SOT-223	O	G	I	Tape Reel
81NXXL-①-AB3-E-R	81NXXG-①-AB3-E-R				SOT-89	O	I	G	Tape Reel
81NXXL-①-AE3-3-R	81NXXG-①-AE3-3-R				SOT-23	O	G	I	Tape Reel
81NXXL-①-AE3-5-R	81NXXG-①-AE3-5-R				SOT-23	G	O	I	Tape Reel
81NXXL-①-AE3-2-R	81NXXG-①-AE3-2-R				SOT-23	I	O	G	Tape Reel
81NXXL-①-AE2-3-R	81NXXG-①-AE2-3-R				SOT-23-3	O	G	I	Tape Reel
81NXXL-①-AE2-5-R	81NXXG-①-AE2-5-R				SOT-23-3	G	O	I	Tape Reel
81NXXL-①-AE2-2-R	81NXXG-①-AE2-2-R				SOT-23-3	I	O	G	Tape Reel
81NXXL-①-T92-D-B	81NXXG-①-T92-D-B				TO-92	I	G	O	Tape Box
81NXXL-①-T92-E-B	81NXXG-①-T92-E-B				TO-92	O	I	G	Tape Box
81NXXL-①-T92-D-K	81NXXG-①-T92-D-K				TO-92	I	G	O	Bulk
81NXXL-①-T92-E-K	81NXXG-①-T92-E-K				TO-92	O	I	G	Bulk
81NXXL-①-T92-D-R	81NXXG-①-T92-D-R				TO-92	I	G	O	Tape Reel
81NXXL-①-T92-E-R	81NXXG-①-T92-E-R				TO-92	O	I	G	Tape Reel

Note: 1. Pin assignment: I:V_{IN} O:V_{OUT} G:V_{SS}

2. XX: Output Voltage, refer to Marking Information.

<p>81CXXL-①-AA3-x-R</p>	<ul style="list-style-type: none"> (1)Packing Type (2)Pin Code (3)Package Type (4)Delay Time (5)Lead Free (6)Output Voltage Code (7)Output Configuration 	<ul style="list-style-type: none"> (1) R: Tape Reel, B: Tape Box, K: Bulk (2) refer to Pin Assignment (3) AA3: SOT-223,AE2: SOT-23-3 AB3: SOT-89, AE3: SOT-23, T92: TO-92, (4) ①: refer to Delay Time (5) G: Halogen Free, L: Lead Free (6) XX: refer to Marking Information (7) C: CMOS, N: N-Channel
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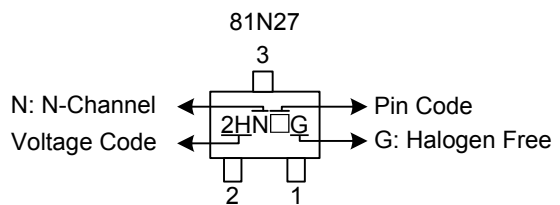
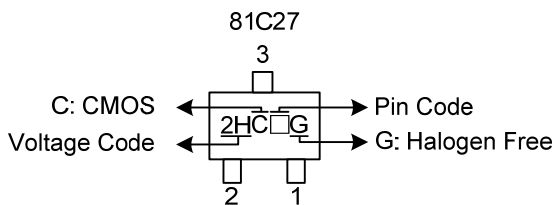
MARKING INFORMATION

PACKAGE	VOLTAGE CODE			MARKING
SOT-223	10:1.0V	26:2.6V	42:4.2V 43:4.3V 44:4.4V 45:4.5V 46:4.6V 47:4.7V 48:4.8V 49:4.9V 50:5.0V	
	11:1.1V	27:2.7V		
	12:1.2V	28:2.8V		
	13:1.3V	29:2.9V		
	14:1.4V	30:3.0V		
SOT-89	15:1.5V	31:3.1V		
	16:1.6V	32:3.2V		
	17:1.7V	33:3.3V		
	18:1.8V	34:3.4V		
	19:1.9V	35:3.5V		
TO-92	20:2.0V	36:3.6V		
	21:2.1V	37:3.7V		
	22:2.2V	38:3.8V		
	23:2.3V	39:3.9V		
	24:2.4V	40:4.0V		
	25:2.5V	41:4.1V		

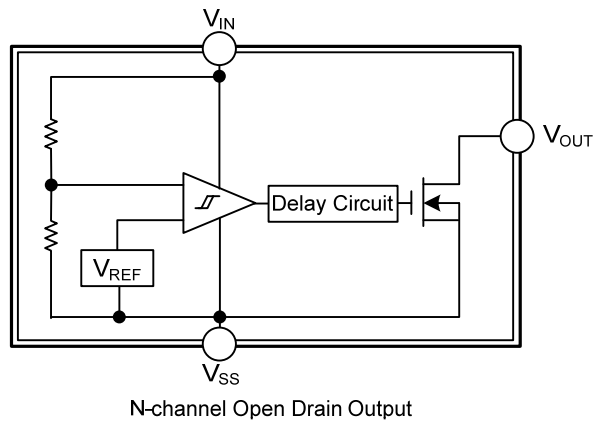
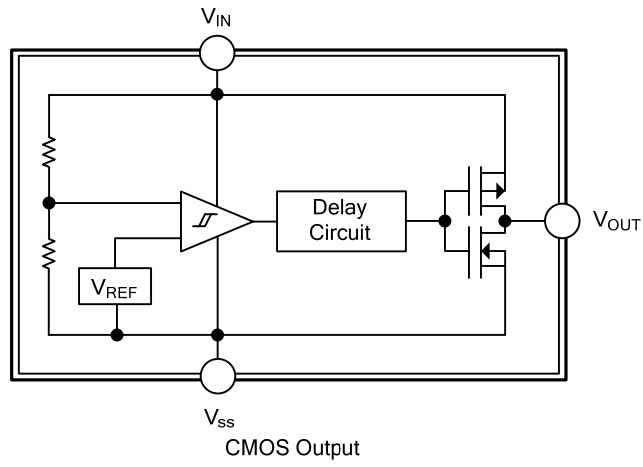
PACKAGE	INTEGER (Note 1)	CODE	DECIMAL (Note 2)	CODE	MARKING
SOT-23 SOT-23-3	1.	1	.0	A	
	2.	2	.1	B	
	3.	3	.2	C	
	4.	4	.3	D	
	5.	5	.4	E	
	6.	6	.5	F	
			.6	G	
			.7	H	
			.8	J	
			.9	K	

Notes: 1. Represents the integer of the Detect Voltage
 2. Represents the decimal number of the Detect Voltage

EXAMPLE:



■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS (T_A=25°C)

PARAMETER		SYMBOL	RATINGS	UNIT
Input Voltage		V _{IN}	12	V
Output Current		I _{OUT}	50	mA
Output Voltage	CMOS	V _{OUT}	V _{SS} -0.3 ~ V _{IN} +0.3	V
	N-Ch open drain		V _{SS} -0.3 ~ 9	V
Power Dissipation	SOT-223	P _D	800	mW
	SOT-23/ SOT-23-3		150	
	SOT-89		500	
	TO-92		300	
Operating Temperature		T _{OPR}	-30 ~ +85	°C
Storage Temperature		T _{STG}	-40 ~ +125	°C

Note Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Case	SOT-223	θ _{JC}	20	°C/W
	SOT-23/ SOT-23-3		200	
	SOT-89		45	
	TO-92		100	

■ ELECTRICAL CHARACTERISTICS (T_A=25°C)

Detection voltage (1.0V ~ 1.9V)

PARAMETER		SYMBOL	CIRCUIT	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Detect Voltage		V _{DF}	1		V _{DF} (T) ×0.98	V _{DF} (T)	V _{DF} (T) ×1.02	V
Hysteresis Range		V _{HYS}	1		V _{DF} ×0.02	V _{DF} ×0.05	V _{DF} ×0.08	V
Operating Voltage		V _{IN}	1	V _{DF} =1.6V ~ 6.0V	0.7		10.0	V
Supply Current		I _{SS}	2	V _{IN} =1.5V		0.9	2.6	μA
				V _{IN} =5.0		2.0	4.2	μA
Output Current	N-Channel	I _{OUT}	3	V _{DS} =0.5V, V _{IN} =1.0V		2.2		mA
	P- Channel		4	V _{DS} =2.1V, V _{IN} =8.0V (CMOS output)		-15.4		mA
V _{DF} Temperature Characteristics		$\frac{\Delta V_{DF}}{\Delta T_{OPR} \times V_{DF}}$				±100		ppm/°C
Transient Delay Time (V _{DR} → V _{OUT} inversion)		t _{DLY} *	5	V _{IN} changes from 0.6V ~ 10V	50		200	ms

■ ELECTRICAL CHARACTERISTICS(Cont.)

Detection voltage (2.0V ~ 2.9V)

PARAMETER	SYMBOL	CIRCUIT	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Detect Voltage	V_{DF}	1		$V_{DF} (T) \times 0.98$	$V_{DF} (T)$	$V_{DF} (T) \times 1.02$	V
Hysteresis Range	V_{HYS}	1		$V_{DF} \times 0.02$	$V_{DF} \times 0.05$	$V_{DF} \times 0.08$	V
Operating Voltage	V_{IN}	1	$V_{DF}=1.6V \sim 6.0V$	0.7		10.0	V
Supply Current	I_{SS}	2	$V_{IN}=2.0V$		1.0	3.0	μA
			$V_{IN}=5.0V$		2.0	4.2	μA
Output Current	N-Channel	I_{OUT}	3	$V_{DS}=0.5V, V_{IN}=2.0V$		7.9	mA
	P- Channel		4	$V_{DS}=2.1V, V_{IN}=8.0V$ (CMOS output)		-15.4	mA
V_{DF} Temperature Characteristics	$\frac{\Delta V_{DF}}{\Delta T_{OPR} \times V_{DF}}$				± 100		ppm/ $^{\circ}C$
Transient Delay Time ($V_{DR} \rightarrow V_{OUT}$ inversion)	t_{DLY}^*	5	V_{IN} changes from 0.6V ~ 10V	50		200	ms

Detection voltage (3.0V ~ 3.9V)

PARAMETER	SYMBOL	CIRCUIT	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Detect Voltage	V_{DF}	1		$V_{DF} (T) \times 0.98$	$V_{DF} (T)$	$V_{DF} (T) \times 1.02$	V
Hysteresis Range	V_{HYS}	1		$V_{DF} \times 0.02$	$V_{DF} \times 0.05$	$V_{DF} \times 0.08$	V
Operating Voltage	V_{IN}	1	$V_{DF}=1.6V \sim 6.0V$	0.7		10.0	V
Supply Current	I_{SS}	2	$V_{IN}=3.0V$		1.3	3.4	μA
			$V_{IN}=5.0V$		2.0	4.2	μA
Output Current	N-Channel	I_{OUT}	3	$V_{DS}=0.5V, V_{IN}=3.0V$		10.1	mA
	P- Channel		4	$V_{DS}=2.1V, V_{IN}=8.0V$ (CMOS output)		-15.4	mA
V_{DF} Temperature Characteristics	$\frac{\Delta V_{DF}}{\Delta T_{OPR} \times V_{DF}}$				± 100		ppm/ $^{\circ}C$
Transient Delay Time ($V_{DR} \rightarrow V_{OUT}$ inversion)	t_{DLY}^*	5	V_{IN} changes from 0.6V ~ 10V	50		200	ms

■ ELECTRICAL CHARACTERISTICS(Cont.)

Detection voltage (4.0V ~ 4.9V)

PARAMETER	SYMBOL	CIRCUIT	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Detect Voltage	V_{DF}	1		$V_{DF}(T) \times 0.98$	$V_{DF}(T)$	$V_{DF}(T) \times 1.02$	V
Hysteresis Range	V_{HYS}	1		$V_{DF} \times 0.02$	$V_{DF} \times 0.05$	$V_{DF} \times 0.08$	V
Operating Voltage	V_{IN}	1	$V_{DF}=1.6V \sim 6.0V$	0.7		10.0	V
Supply Current	I_{SS}	2	$V_{IN}=4.0V$		1.5	3.8	μA
			$V_{IN}=5.0V$		2.0	4.2	μA
Output Current	N-Channel	I_{OUT}	3	$V_{DS}=0.5V, V_{IN}=4.0V$		11.5	mA
	P- Channel		4	$V_{DS}=2.1V, V_{IN}=8.0V$ (CMOS output)		-15.4	mA
V_{DF} Temperature Characteristics	$\frac{\Delta V_{DF}}{\Delta T_{OPR} \times V_{DF}}$				± 100		ppm/ $^{\circ}C$
Transient Delay Time ($V_{DR} \rightarrow V_{OUT}$ inversion)	t_{DLY}^*	5	V_{IN} changes from 0.6V ~ 10V	50		200	ms

Detection voltage (5.0V)

PARAMETER	SYMBOL	CIRCUIT	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Detect Voltage	V_{DF}	1		$V_{DF}(T) \times 0.98$	$V_{DF}(T)$	$V_{DF}(T) \times 1.02$	V
Hysteresis Range	V_{HYS}	1		$V_{DF} \times 0.02$	$V_{DF} \times 0.05$	$V_{DF} \times 0.08$	V
Operating Voltage	V_{IN}	1	$V_{DF}=1.6V \sim 6.0V$	0.7		10.0	V
Supply Current	I_{SS}	2	$V_{IN}=5.0V$		2.0	4.2	μA
Output Current	N-Channel	I_{OUT}	3	$V_{DS}=0.5V, V_{IN}=5.0V$		13.0	mA
	P- Channel		4	$V_{DS}=2.1V, V_{IN}=8.0V$ (CMOS output)		-15.4	mA
V_{DF} Temperature Characteristics	$\frac{\Delta V_{DF}}{\Delta T_{OPR} \times V_{DF}}$				± 100		ppm/ $^{\circ}C$
Transient Delay Time ($V_{DR} \rightarrow V_{OUT}$ inversion)	t_{DLY}^*	5	V_{IN} changes from 0.6V ~ 10V	50		200	ms

$V_{DF}(T)$: established detect voltage value

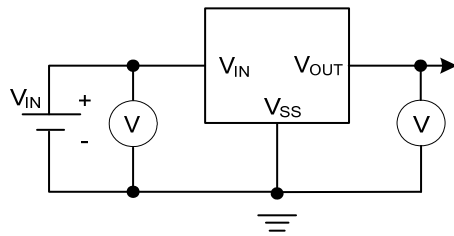
Release Voltage: $V_{DR} = V_{DF} + V_{HYS}$

* Transient Delay Time: 1ms ~ 50ms & 200ms ~ 400ms versions are also available.

Note: The power consumption during power-start to output being stable (release operation) is 2 μA greater than it is after that period (completion of release operation) because of delay circuit through current.

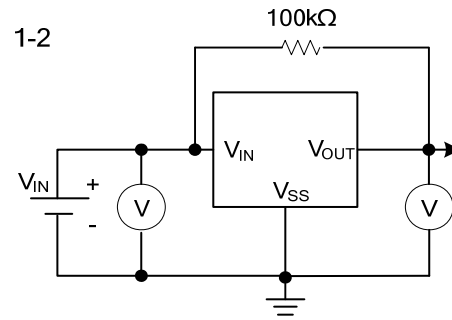
■ TEST CIRCUITS

1-1



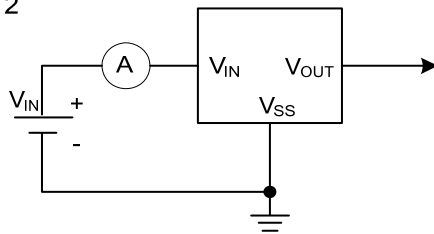
Cmos Output

1-2

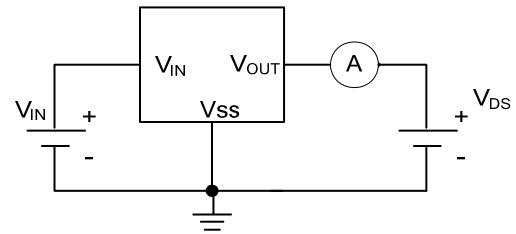


N-channel Open Drain Output

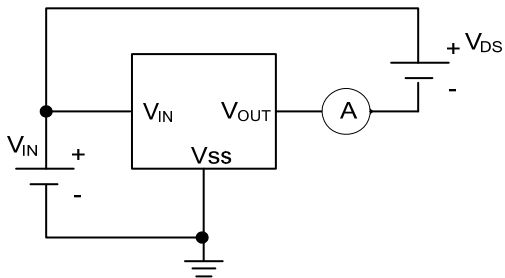
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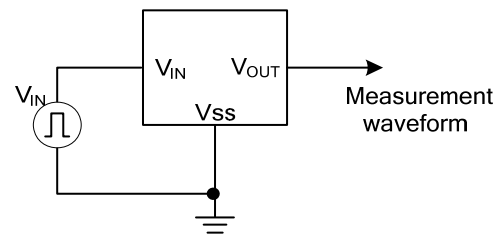
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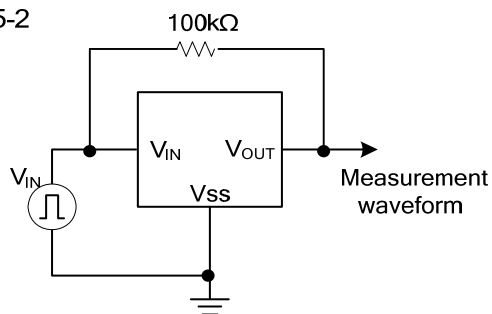


5-1



Cmos Output

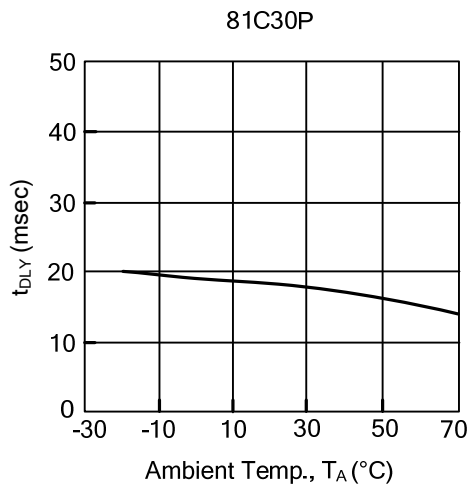
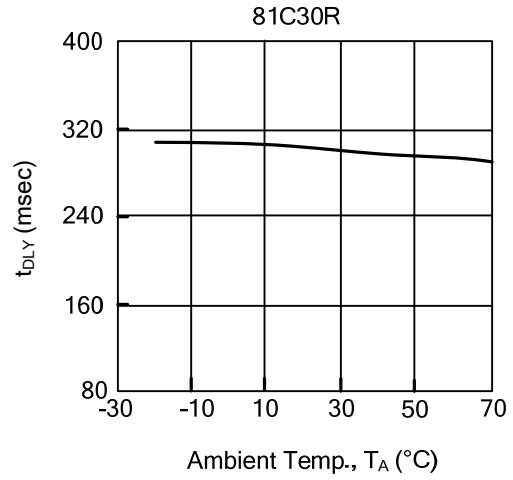
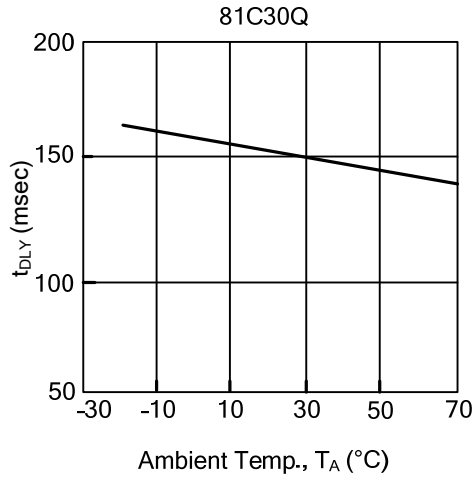
5-2



N-channel Open Drain Output

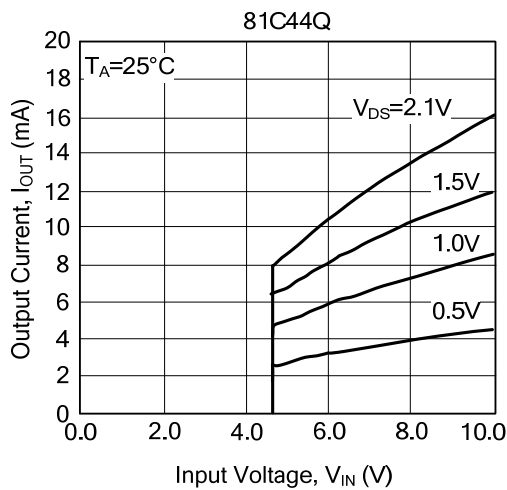
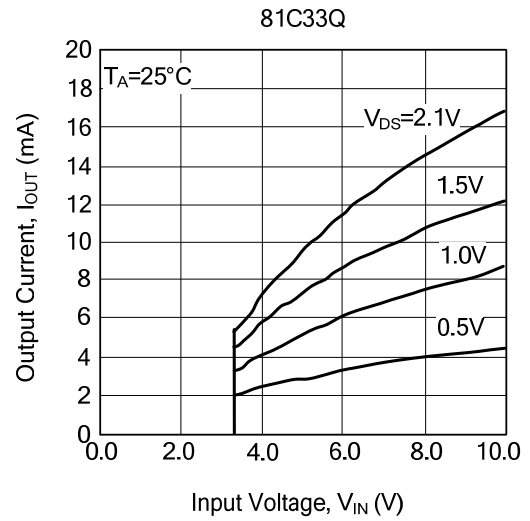
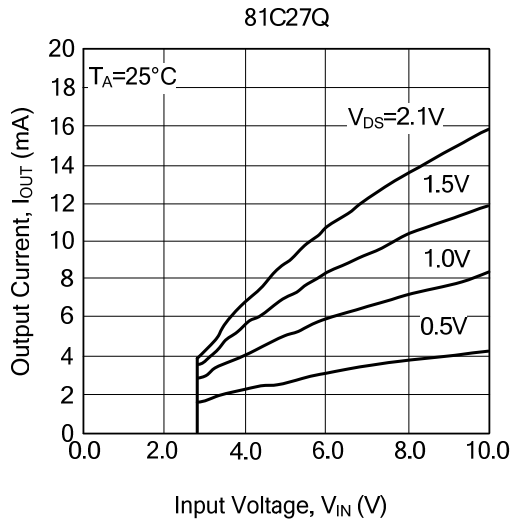
■ TYPICAL PERFORMANCE CHARACTERISTICS

(1) Ambient Temperature vs. Transient Delay Time

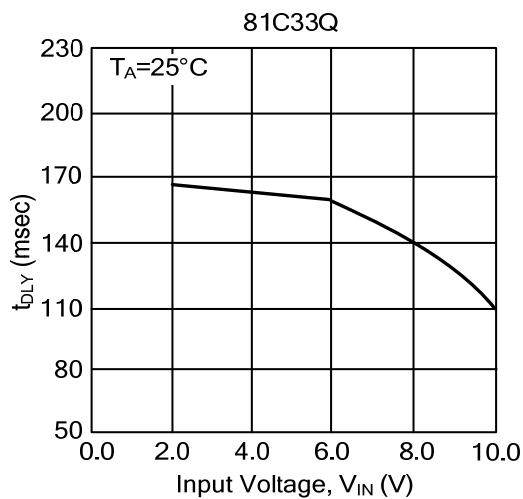


■ TYPICAL PERFORMANCE CHARACTERISTICS(Cont.)

(2) P-Channel Driver Output Current vs. Input Voltage

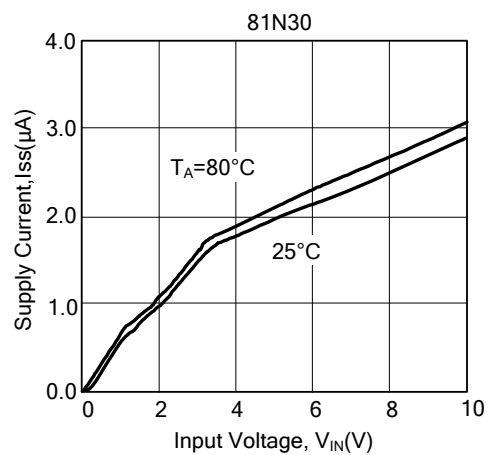
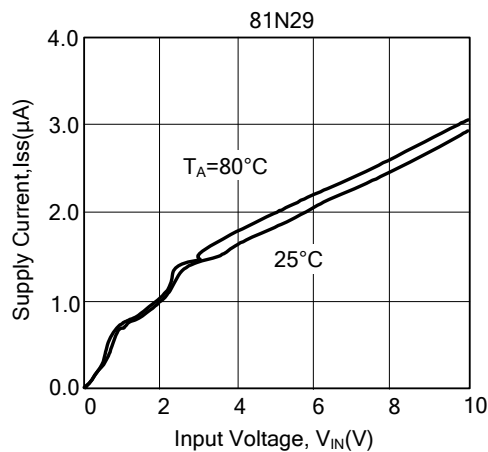
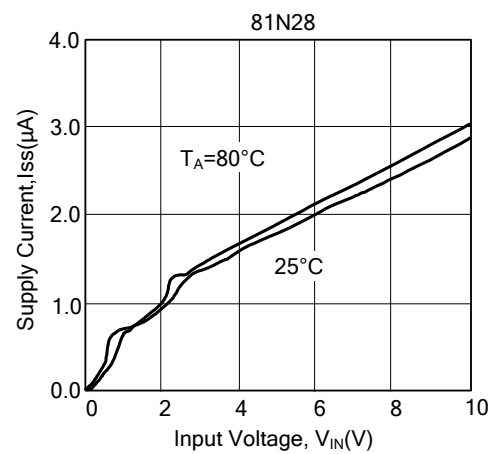
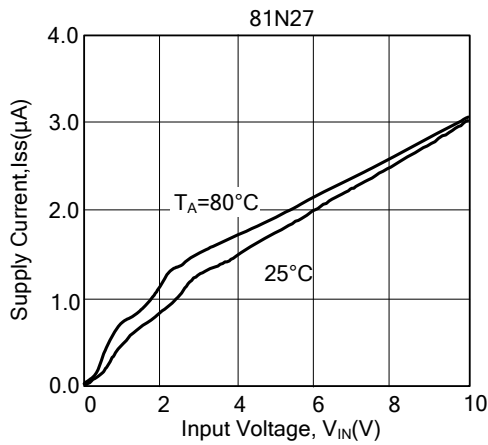
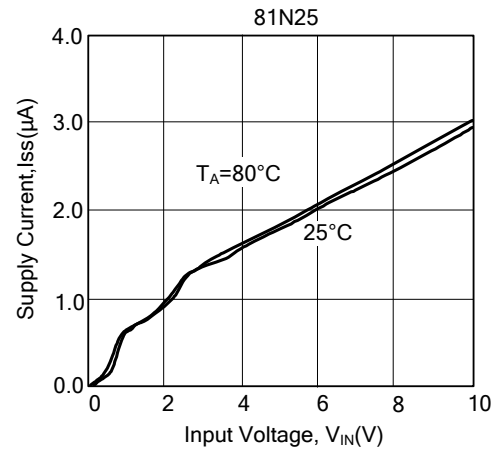
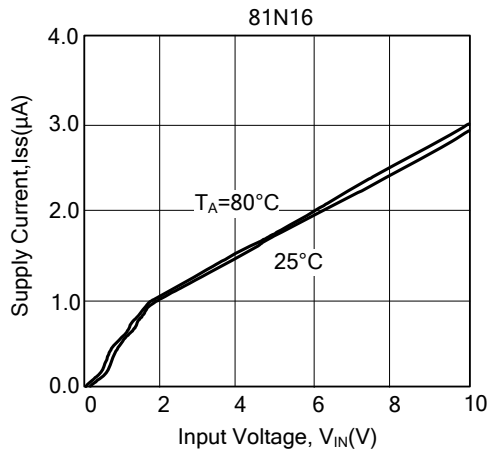


(2) Transient Delay Time vs. Input Voltage

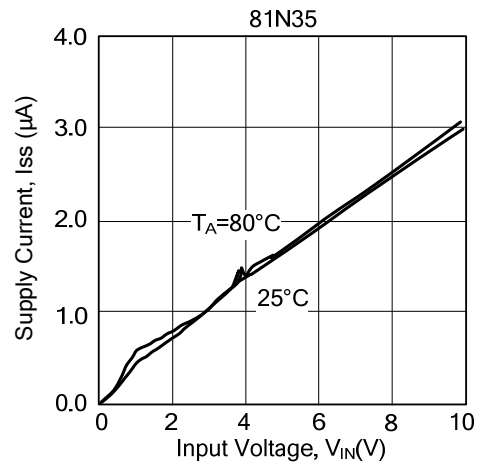
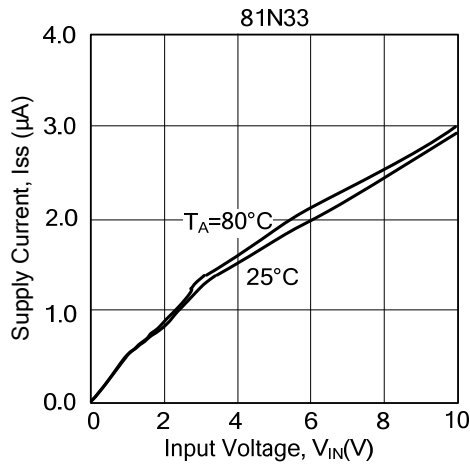


■ TYPICAL PERFORMANCE CHARACTERISTICS(Cont.)

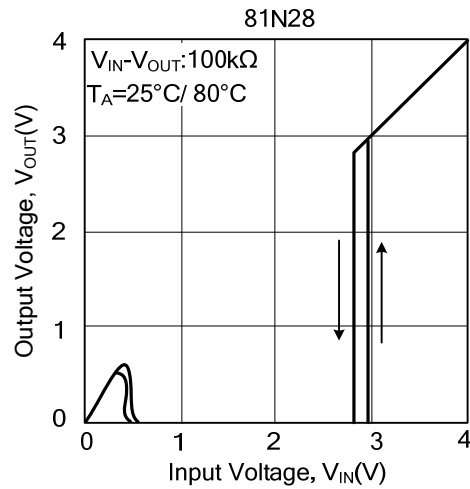
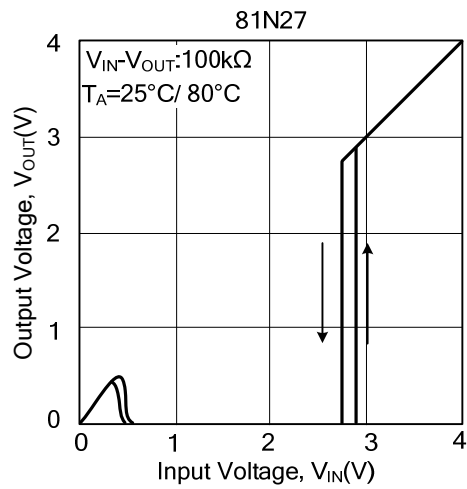
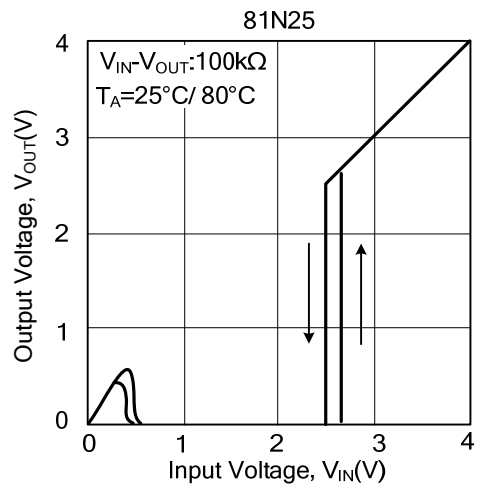
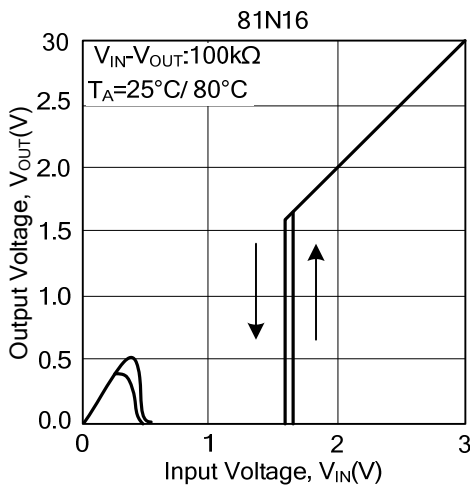
(3) Supply Current vs. Input Voltage



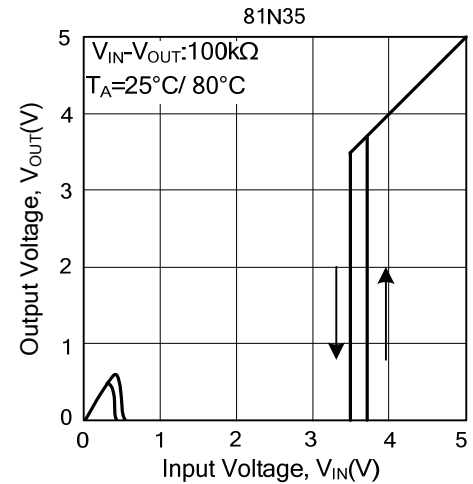
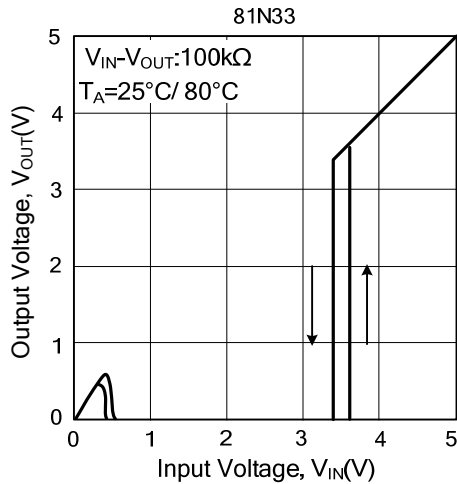
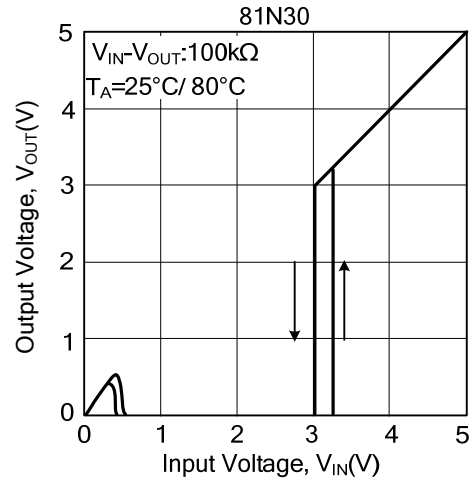
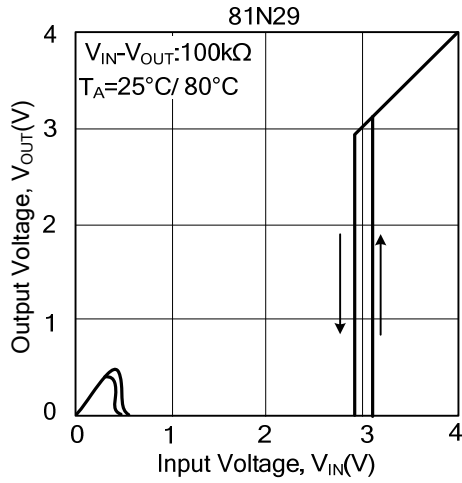
■ TYPICAL PERFORMANCE CHARACTERISTICS(Cont.)



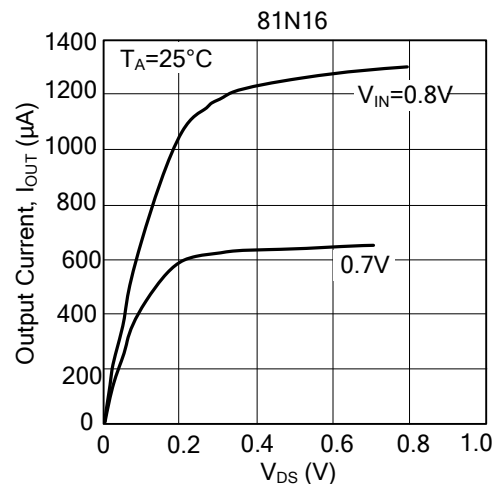
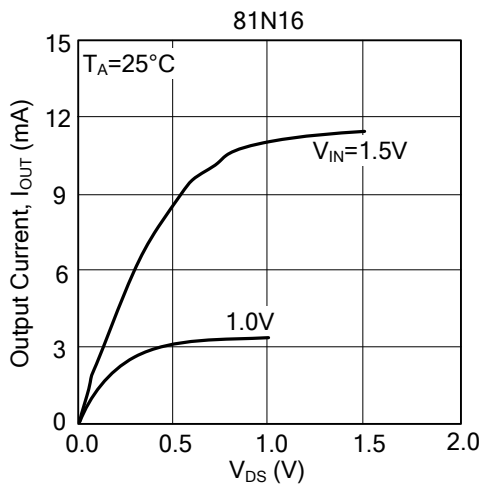
(4) Output Voltage vs. Input Voltage



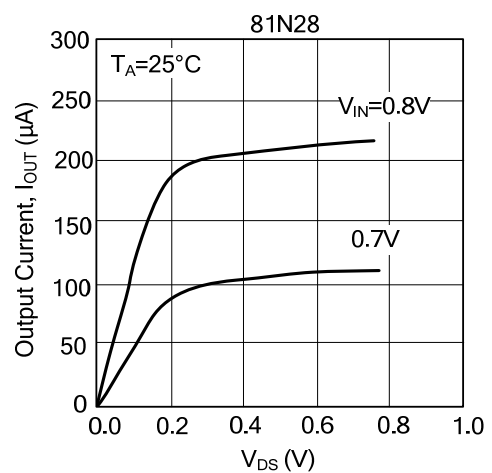
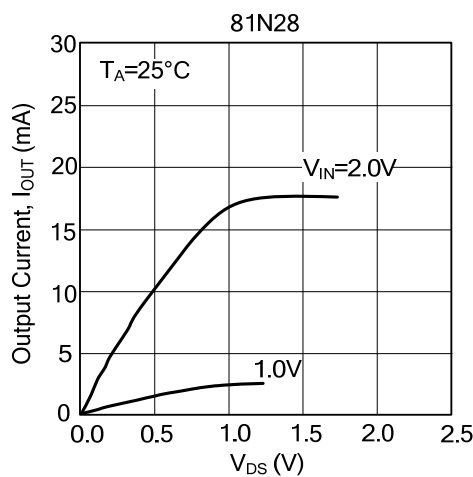
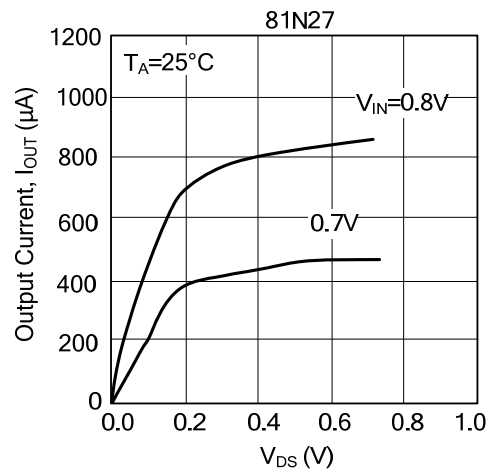
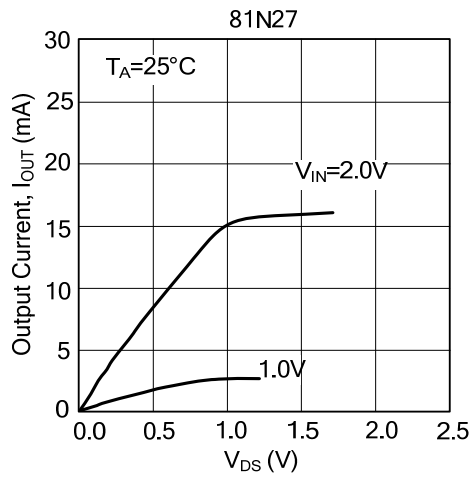
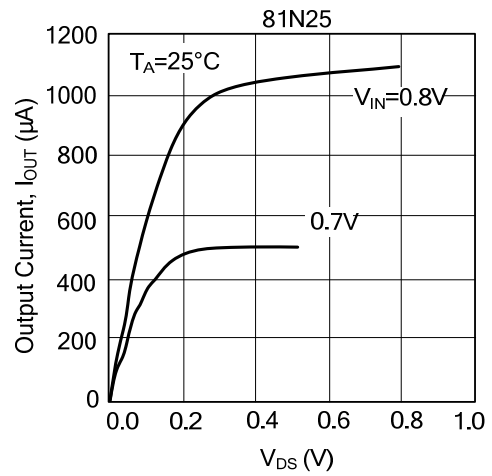
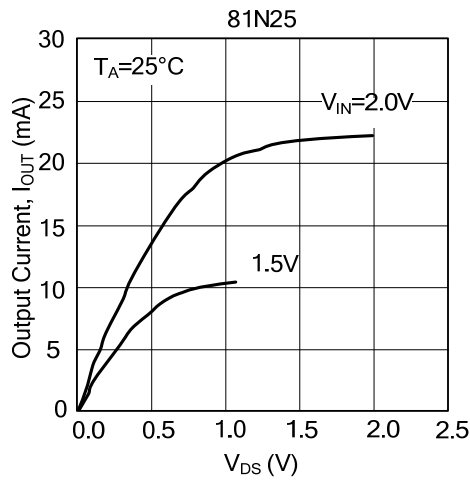
■ TYPICAL PERFORMANCE CHARACTERISTICS(Cont.)



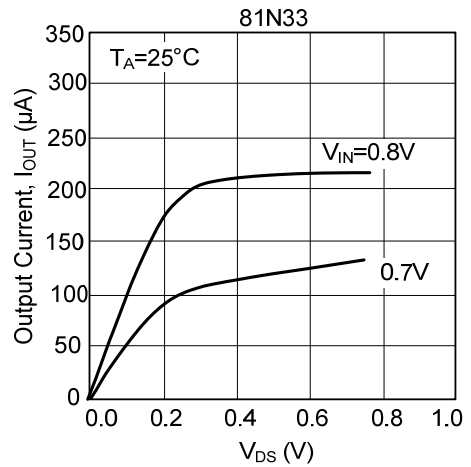
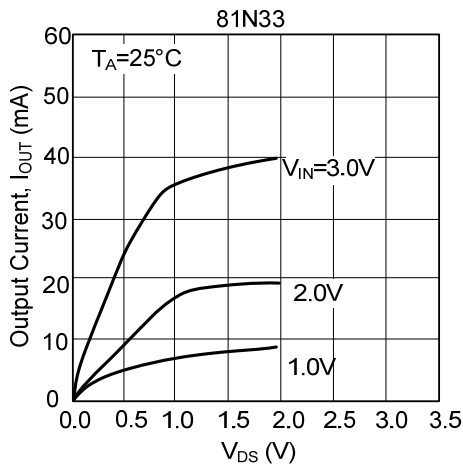
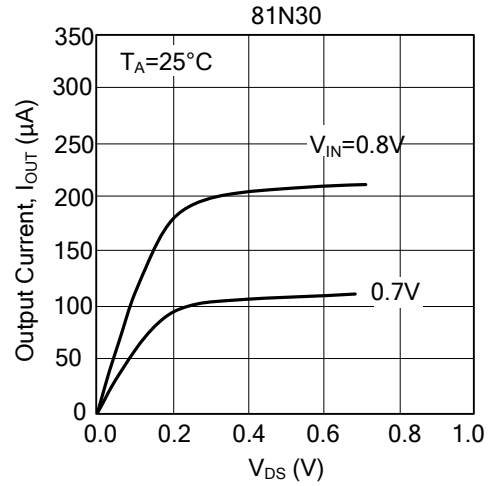
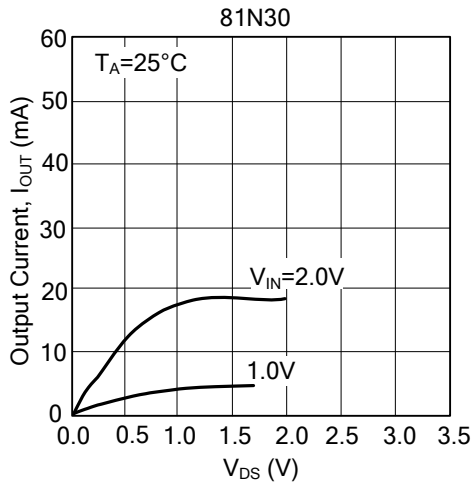
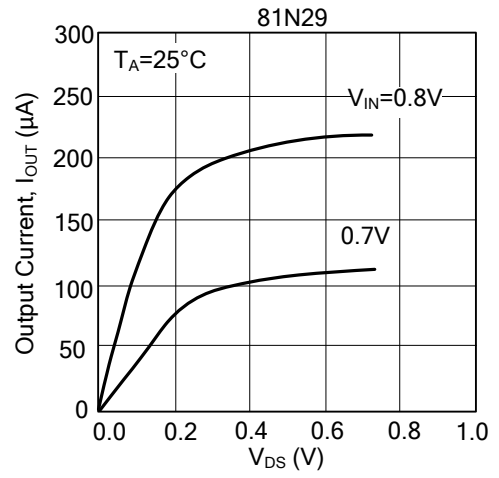
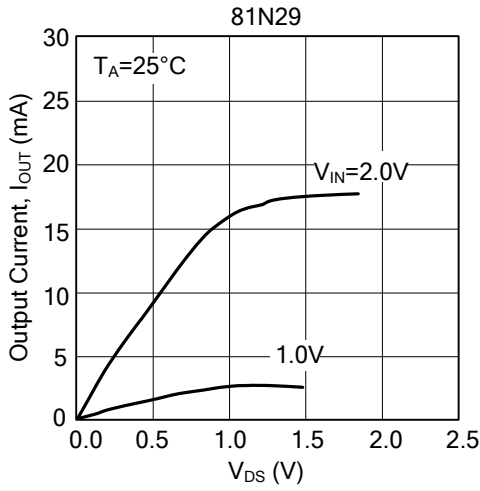
(5) N-Channel Drive Output Current vs. V_{DS}



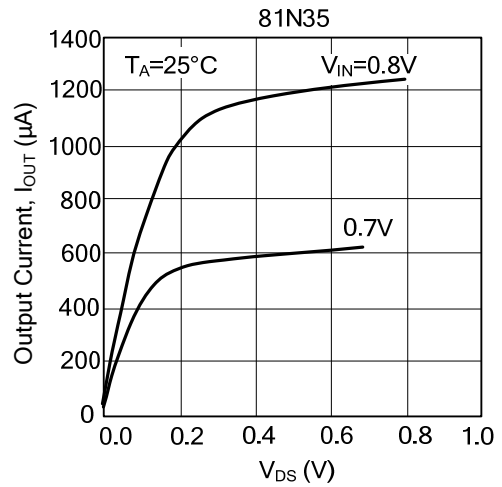
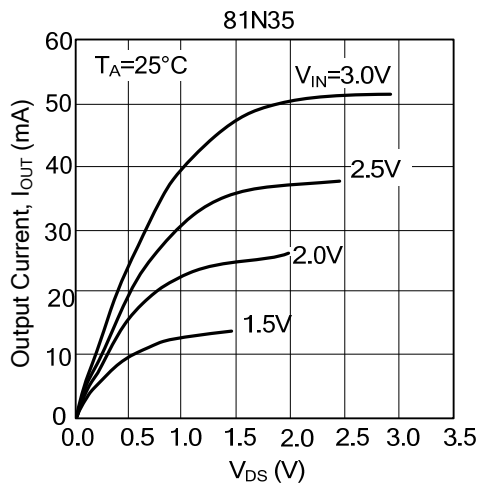
■ TYPICAL PERFORMANCE CHARACTERISTICS(Cont.)



■ TYPICAL PERFORMANCE CHARACTERISTICS(Cont.)



■ TYPICAL PERFORMANCE CHARACTERISTICS(Cont.)



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